

RoHS

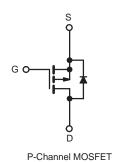
COMPLIANT

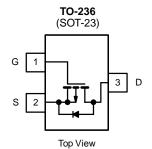
P-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	- 60			
R _{DS(on)} (Ω)	V _{GS} = - 10 V	0.04		
Q _g (Max.) (nC)	12			
Q _{gs} (nC)	3.8			
Q _{gd} (nC)	5.1			
Configuration	Single			

FEATURES

- Isolated Package
- High Voltage Isolation = $2.5 \text{ kV}_{\text{RMS}}$ (t = 60 s; f = 60 Hz)
- Sink to Lead Creepage Distance = 4.8 mm
- P-Channel
- 175 °C Operating Temperature
- Dynamic dV/dt Rating
- · Low Thermal Resistance
- Lead (Pb)-free Available





PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage		V _{DS}	- 60	V	
Gate-Source Voltage		V _{GS}	± 20	v	
Continuous Drain Current	$V_{GS} \text{ at - 10 V} \frac{T_C = 25 \text{ °C}}{T_C = 100 \text{ °C}}$	I _D	- 5.2	А	
Continuous Brain Guirent			- 3.8		
Pulsed Drain Current ^a	I _{DM}	- 21			
Linear Derating Factor			0.18	W/°C	
Single Pulse Avalanche Energy ^b		E _{AS}	120	mJ	
Repetitive Avalanche Currenta	I _{AR}	- 5.2	А		
Repetitive Avalanche Energy ^a		E _{AR}	2.7	mJ	
Maximum Power Dissipation	T _C = 25 °C	PD	27	W	
Peak Diode Recovery dV/dtc		dV/dt	- 4.5	V/ns	
Operating Junction and Storage Temperature Range	T _J , T _{stq}	- 55 to + 175	°C		
Soldering Recommendations (Peak Temperature)	for 10 s		300 ^d	7	
Mounting Torque	6-32 or M3 screw		10	lbf ⋅ in	
Mounting Torque	0-32 OF M3 SCIEW		1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. $V_{DD} = -25$ V, starting $T_J = 25$ °C, L = 5.0 mH, $R_G = 25 \Omega$, $I_{AS} = -5.3$ A (see fig. 12). c. $I_{SD} \le -6.7$ A, dI/dt ≤ 90 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 175$ °C.

d. 1.6 mm from case.

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PARAMETER	SYMBOL	TYP	P. MAX.			UNIT		
Maximum Junction-to-Ambient	R _{thJA}	- 65 - 5.5			°C/W			
Maximum Junction-to-Case (Drain)	R _{thJC}							
SPECIFICATIONS T _J = 25 °C, u	unless other	wise noted						
PARAMETER	SYMBOL			ONS	MIN.	TYP.	MAX.	
Static								
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	: 0 V, I _D = - 2	50 µA	- 60	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference	e to 25 °C, I _C) = - 1 mA	-	- 0.060	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}		V _{GS} , I _D = - 2		- 1.0	-	- 2.5	V
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 20 V$		-	-	± 100	nA
		$V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	- 100	+	
Zero Gate Voltage Drain Current	I _{DSS}		V _{GS} = 0 V, 7		-	-	- 500	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = - 10 V	1		-	0.05	-	Ω
Forward Transconductance		-	- 25 V, I _D = -	3.2 A ^b	1.6	-	-	S
Dynamic								
Input Capacitance	C _{iss}	<u></u>		-	270	-	Γ	
Output Capacitance	C _{oss}		V _{GS} = 0 V, V _{DS} = - 25 V,		-	170	-	1
Reverse Transfer Capacitance	C _{rss}	f = 1.0 MHz, see fig. 5		-	31	-	pF	
Drain to Sink Capacitance	С		f = 1.0 MHz		-	12	-	
Total Gate Charge	Qg			-	-	12	1	
Gate-Source Charge	Q _{gs}	V _{GS} = - 10 V	$V_{GS} = -10 \text{ V}$ $I_D = -4.7 \text{ A}, V_{DS} = -48 \text{ V},$ see fig. 6 and 13^{b}		-	-	3.8	nC
Gate-Drain Charge	Q _{gd}				-	-	5.1	
Turn-On Delay Time	t _{d(on)}	$V_{DD} = -30 \text{ V}, \text{ I}_{D} = -4.7 \text{ A}, \\ \text{R}_{G} = 24 \Omega, \text{ R}_{D} = 4.0 \Omega, \\ \text{see fig. } 10^{\text{b}}$		-	11	-	- ns	
Rise Time	t _r			-	63	-		
Turn-Off Delay Time	t _{d(off)}			-	9.6	-		
Fall Time	t _f			-	31	-		
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	nH	
Internal Source Inductance	Ls			-	7.5	-		
Drain-Source Body Diode Characteristic	S							
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	- 5.2	A	
Pulsed Diode Forward Current ^a	I _{SM}			-	-	- 21		
Body Diode Voltage	V_{SD}	T _J = 25 °C,	I _S = - 5.2 A,	$V_{GS} = 0 V^{b}$	-	-	- 5 .5	V
Body Diode Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = - 4.7 A, dl/dt = 100 A/µs ^b		-	80	160	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	ij = 25 0, IF	+. <i>i</i> A, ul/	ui – 100 A/µ5°	-	0.096	0.19	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	urn-on time is	negligible (turn	-on is dor	ninated by	leand	D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 $\mu s;$ duty cycle \leq 2 %.



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

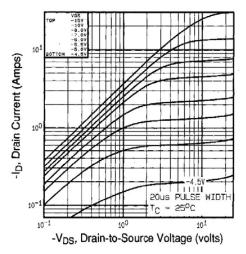


Fig. 1 - Typical Output Characteristics, T_C= 25 °C

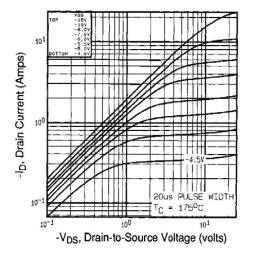


Fig. 2 - Typical Output Characteristics, $T_C\text{=}$ 175 $^\circ\text{C}$

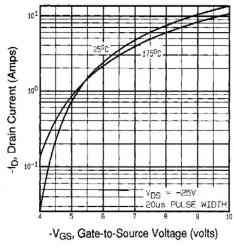


Fig. 3 - Typical Transfer Characteristics

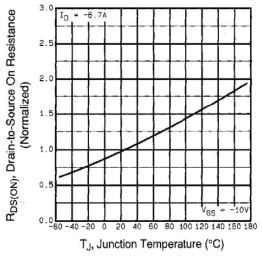


Fig. 4 - Normalized On-Resistance vs. Temperature

ZXMP6A13FTA



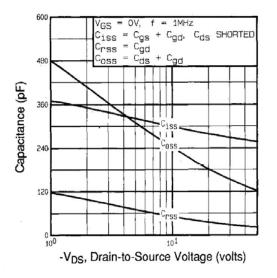
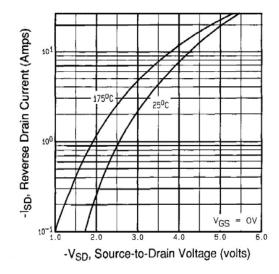


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





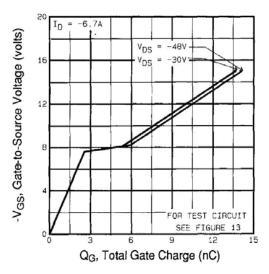


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

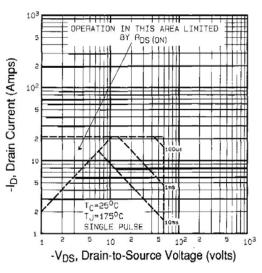


Fig. 8 - Maximum Safe Operating Area



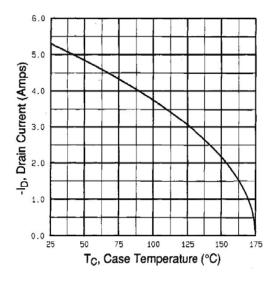


Fig. 9 - Maximum Drain Current vs. Case Temperature

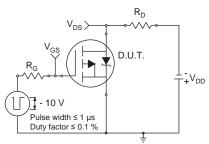


Fig. 10a - Switching Time Test Circuit

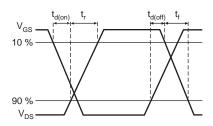
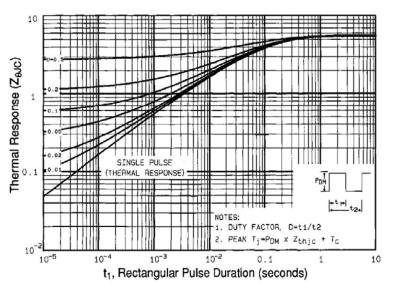


Fig. 10b - Switching Time Waveforms





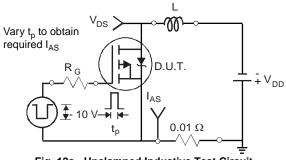
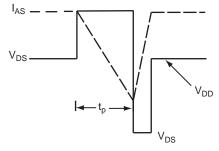
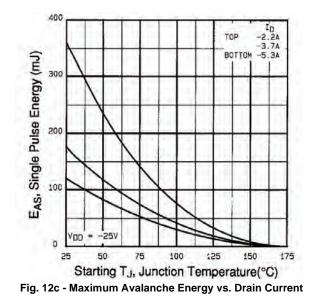


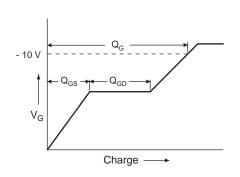
Fig. 12a - Unclamped Inductive Test Circuit











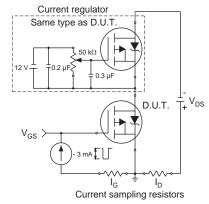
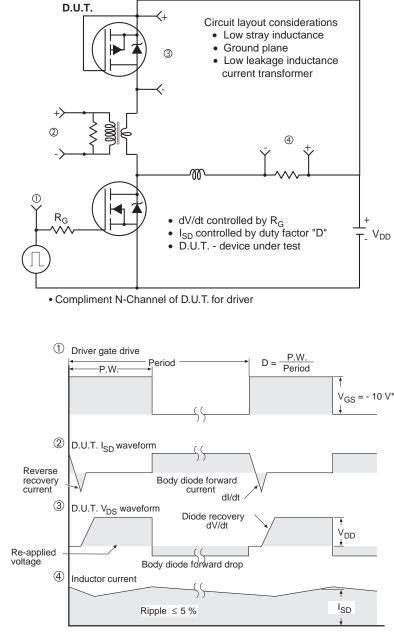
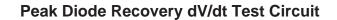


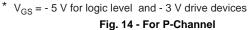
Fig. 13a - Basic Gate Charge Waveform

Fig. 13b - Gate Charge Test Circuit











SOT-23 (TO-236): 3-LEAD







Dim -	MILLIM	IETERS	INCHES		
	Min	Max	Min	Max	
Α	0.89	1.12	0.035	0.044	
A ₁	0.01	0.10	0.0004	0.004	
A ₂	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
C	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E ₁	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e ₁	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L ₁	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	



RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)



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